

BY268

SINTERED GLASS JUNCTION FAST AVALANCHE RECTIFIER

VOLTAGE:1400

CURRENT: 0.8A



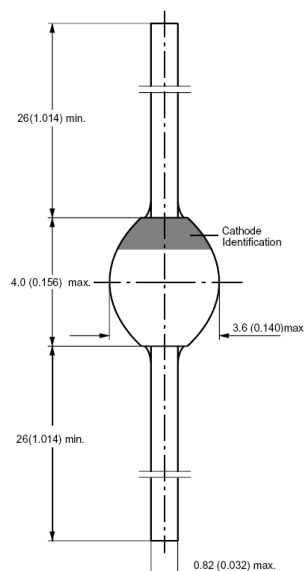
FEATURE

Glass passivated junction
Hermetically sealed package

MECHANICAL DATA

Case: SOD-57 sintered glass case
Terminal: Plated axial leads solderable per
MIL-STD 202E, method 208C
Polarity: color band denotes cathode end
Mounting position: any

SOD-57



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	BY268	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	1400	V
Maximum RMS Voltage	V _{rms}	980	V
Maximum DC blocking Voltage	V _{dc}	1400	V
Non-Repetitive Peak Reverse Voltage	V _{rsm}	1600	V
Maximum Average Forward Rectified Current 3/8"lead length at T _a =55°C	I _{f(av)}	0.8	A
Peak Forward Surge Current at T _p =10ms half sinewave	I _{fsm}	20.0	A
Maximum Forward Voltage at 0.4A and 25°C	V _f	1.25	V
Maximum DC Reverse Current at rated DC blocking voltage	I _r	2.0 15.0	μA
Maximum Reverse Recovery Time (Note 1)	T _{rr}	400	nS
Typical Thermal Resistance (Note 2)	R _{th(ja)}	110.0	K/W
Storage and Operating Junction Temperature	T _{stg} , T _j	-65 to +175	°C

Note:

1. Reverse Recovery Condition I_f =0.5A, I_r =1.0A, I_{rr} =0.25A
2. Thermal Resistance from Junction to Ambient on P.C. board with spacing 25mm

RATINGS AND CHARACTERISTIC CURVES BY268

Figure 1. Typ. Thermal Resistance vs. Lead Length

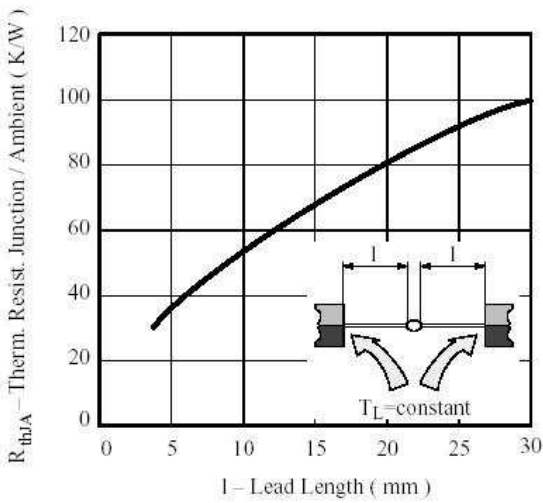


Figure 2. Reverse Current vs. Junction Temperature

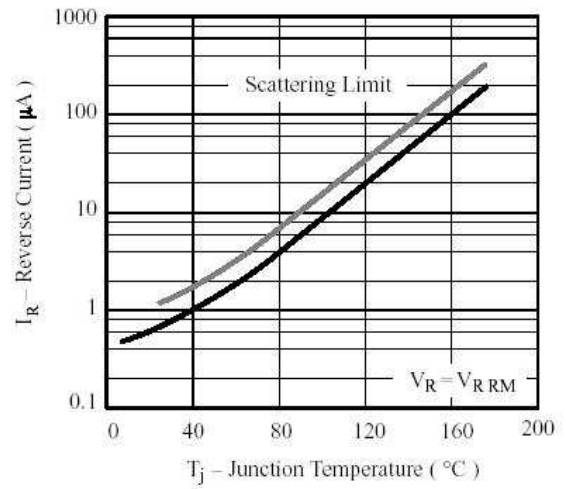


Figure 3. Typ. Forward Current vs. Forward Voltage

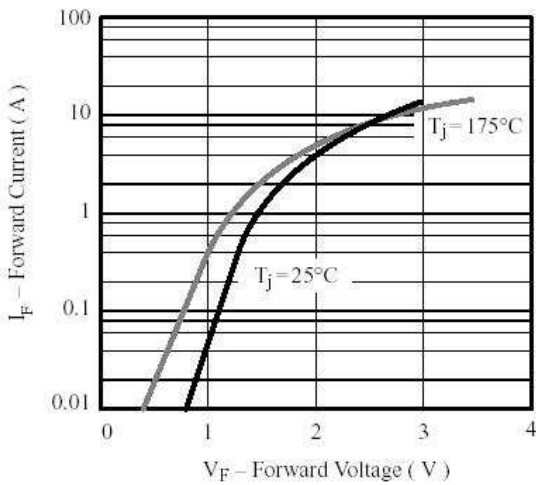


Figure 4. Typ. Diode Capacitance vs. Reverse Voltage

